Trusted Foundry Program

As of 2/22/2013

Accredited Suppliers

Important: Many of the following suppliers have a standard commercial (untrusted) product flow in addition to a trusted product flow. The "Trusted Product Flow" must be explicitly requested from the points of contact below to ensure the resulting product and/or service is trusted. A trusted supply chain begins with trusted design and continues with trusted mask, foundry, packaging/assembly, and test services.

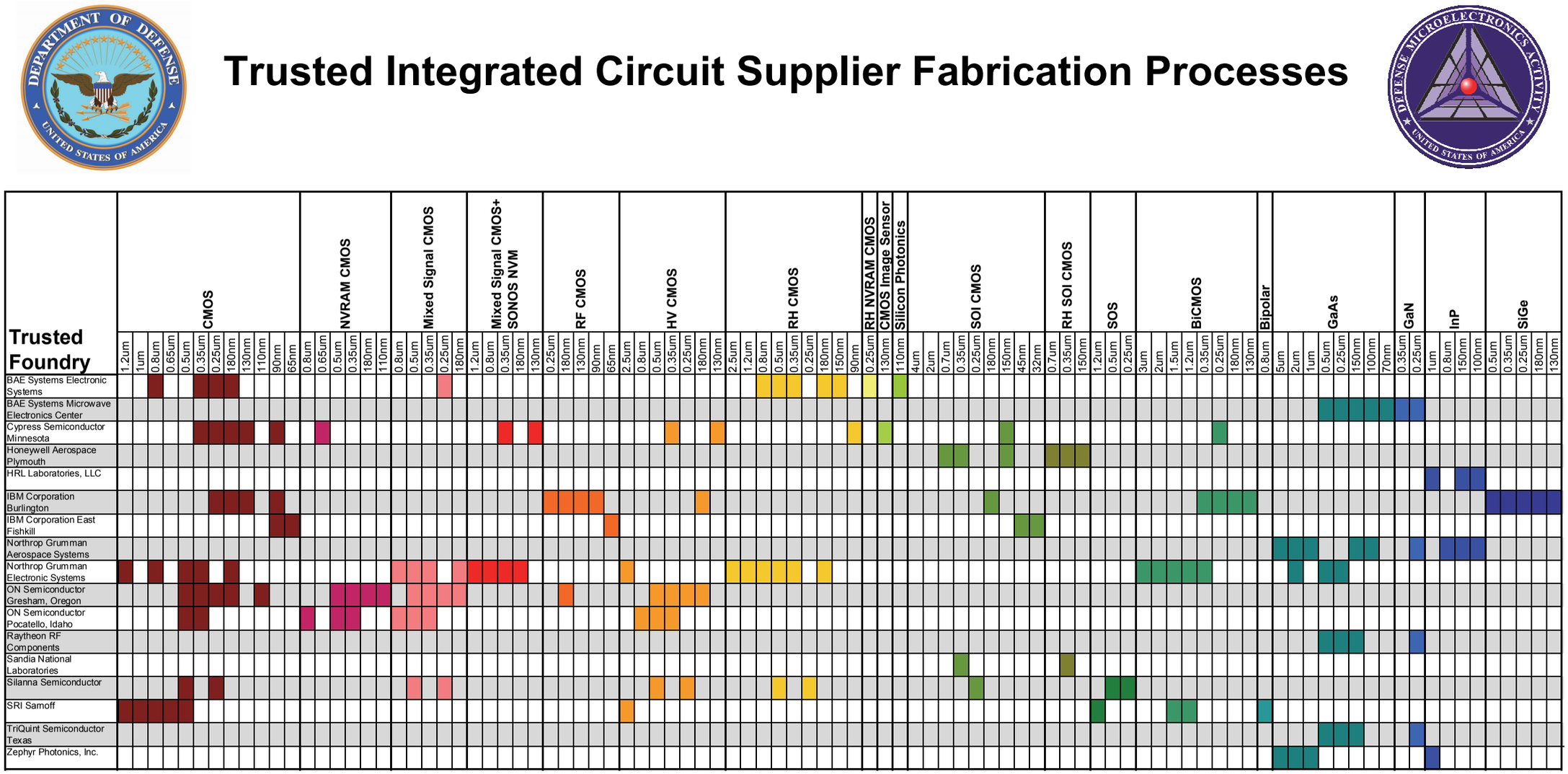
Supplier	CAGE Code	Facility Location	Scope of Accreditation	POC	Email Address	Telephone Number
Abraxas Corporation	5GW01	Annapolis Junction, MD	Design	Vice President of Maryland operations	john.etgen@abraxascorp.com	(301) 490-9816 x2001
Advotech Company, Inc.	4GBU7	Tempe, AZ	Packaging/Assembly	Trusted IC Director	trusted.director@advotech.com	(480) 736-0406
Aeroflex Colorado Springs	65342	Colorado Springs, CO	Broker; Design; Aggregation; Packaging/Assembly; Test	Danny Wilkin	Danny.Wilkin@aeroflex.com	(719) 594-8131
Aeroflex Plainview, Inc.	88379	Plainview, NY	Packaging/Assembly	Joe Mazzotta	Joe.Mazzotta@aeroflex.com	(516) 752-2359
Analytical Solutions, Inc.	3DR22	Albuquerque, NM	Test	William Bryson QSS/Business Development Manager	sales@asinm.com	(505) 299-1967
Arkham Technology, Ltd.	47RG0	Irvine, CA	Design	Otaway Thomas, CISSP, ISSEP	othomas@arkhamtechnology.com	(949) 228-6677
Atessa, Inc.	66UM6	Pleasanton, CA	Design	Marketing Manager	info@atessainc.com	(925) 469-0063
BAE Systems Electronic Systems	1RU44	Manassas, VA	Design; Foundry Services; Packaging/Assembly; Test	Mr. David Rea, Business Area Manager, Microelectronics	david.a.rea@baesystems.com	(703) 367-4687
BAE Systems Microwave Electronics Center Nashua	94117	Nashua, NH	Foundry Services	Kevin Stewart	kevin.a.stewart@baesystems.com	(603) 885-6743
Boeing Company, The	81205	Seattle, WA	Design	Business Development Manager	ssed@boeing.com	(253) 657-0444
Criteria Labs, Inc.	1NQ10	Austin, TX	Broker; Packaging/Assembly; Test	Doug Myron	dmyron@criterialabs.com	(512) 637-4549 cell (512) 809-1717
Cypress Semiconductor Minnesota, Inc.	5AZZ0	Bloomington, MN	Broker; Design; Foundry Services; Test	Brad Ferguson, PhD, Wafer Foundry Services Business Development Manager	trustedfoundry@cypress.com	(952) 851-5190
Defense Microelectronics Activity	088N9	McClellan, CA	Design; Foundry Services; Packaging/Assembly; Test	Jerry Tucker	tucker@dmea.osd.mil	(916) 231-1593
DPA Components International	6S055	Simi Valley, CA	Packaging/Assembly; Test	Doug Schweitzer	dougs@dpaci.com	(805) 581-9200
e2v aerospace and defense, inc. (was QP Semiconductor)	0C7V7	Milpitas, CA	Broker; Design; Packaging/Assembly; Test	Jim Townsend Dir. Marketing	jim.townsend@e2v-us.com	(408) 585-7177
Endicott Interconnect Technologies, Inc.	3ECL3	Endicott, NY	Packaging/Assembly	Eric Hills, VP of Business Development and Military Defense Programs	Eric.Hills@eitny.com	(607) 755-7319

Exelis Inc. Electronic Systems	6J9P8	Palm Harbor, FL	Design; Aggregation	Matt Gibbens	matt.gibbens@exelisinc.com	(727) 230-8300
General Dynamics Advanced Information Systems Bloomington	3CYA2	Bloomington, MN	Broker; Design	Steve Cammack	steven.cammack@gd-ais.com	(952)921-6149 cell (612)860-9895
General Dynamics AIS - Scottsdale, AZ	4LDG1	Scottsdale, AZ	Broker; Design	Jim Garvey, Manager ASIC Design Center	James.Garvey@gd-ais.com	(480) 586-3355
Harris Corporation Government Communications Systems Division	91417	Melbourne, FL	Design; Packaging/Assembly; Test	Louis Paradiso, Group Leader	lparadis@harris.com	(321) 727-5399
Honeywell Aerospace Plymouth	34168	Plymouth, MN	Design; Foundry Services; Packaging/Assembly; Test	Barry Johnson, Western States Manager	Barry.W.Johnson@honeywell.com	(763) 954-2118
Honeywell Federal Manufacturing & Technologies, LLC/Kansas City Plant	14061	Kansas City, MO	Broker; Design; Aggregation; Packaging/Assembly; Test	Trusted Services Program Lead	tfa@nnsa.doe.gov	(816) 997-7867
HRL Laboratories, LLC.	27457	Malibu, CA	Foundry Services	Alex Margomenos,	admargomenos@hrl.com	(310) 317-5325
Hunter Technology Corporation	55536	Santa Clara, CA	Design; Packaging/Assembly	Jason Seifert	JasonS@hunter-technology.com	(408) 328-9778
IBM Annapolis Junction Design Center	8W884	Annapolis Junction, MD	Design	David Sobczak, Manager, Trusted Foundry	sobczakd@us.ibm.com	(802) 769-2208
IBM Corporation Burlington	15898	Essex Junction, VT	Mask Data Parsing; Mask Manufacturing; Foundry Services; Test	David Sobczak, Manager, Trusted Foundry	sobczakd@us.ibm.com	(802) 769-2208
IBM Corporation East Fishkill	1D185	Hopewell Junction, NY	Foundry Services; Post Processing	David Sobczak, Manager, Trusted Foundry	sobczakd@us.ibm.com	(802) 769-2208
Integra Technologies, LLC	1SRY1	Wichita, KS	Broker; Test	Brett Robinson - Controller/FSO	brett.robinson@integra-tech.com	(316) 630-6805
Intrinsix Corp.	0N6C1	Marlborough, MA	Design	Jim Gobes, CEO	jgobes@intrinsix.com	(508) 658-7658
Lincoln Laboratory, Massachusetts Institute of Technology	3G050	Lexington, MA	Design	Dr. Richard Ralston	Ralston@ll.mit.edu	(781) 981-7803
Luna Innovations Incorporated	0P029	Roanoke, VA	Design	FPGA Trust Contact	fpga@lunainc.com	(540) 769-8400
Maxtek Components Corporation dba Tektronix Component Solutions	06MJ2	Beaverton, OR	Packaging/Assembly; Test	Sales Manager	components@tektronix.com	(800) 462-9835
NATEL Engineering Company, Inc.	09059	Chatsworth, CA	Packaging/Assembly	VP Marketing and Sales	LSargent@natelems.com	(818) 734-6500
Northrop Grumman Aerospace Systems	11982	Redondo Beach, CA	Design; Foundry Services; Packaging/Assembly	John Kane	john.v.kane@ngc.com	(310) 813-8726
Northrop Grumman Electronic	15055	Linthicum, MD	Mask Manufacturing; Foundry Services; Packaging/Assembly	Jeff Miller	j3.miller@ngc.com	(410) 765-3958

NSA Microelectronics Solutions Group	98230	Fort Meade, MD	Design; Packaging/Assembly; Test			
ON Semiconductor - Gresham	5V1J0	Gresham, OR	Broker; Foundry Services	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
ON Semiconductor - Pocatello	31471	Pocatello, ID	Broker; Foundry Services	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
Photronics Texas Allen, Inc.	53Z12	Allen, TX	Mask Data Parsing; Mask Manufacturing	Wayne A. DeCarlo, VP North American Sales	wdecarlo@photronics.com	(203) 740-5356
Raytheon RF Components	05716	Andover, MA	Foundry Services	John Reddick	jreddick@raytheon.com	(978) 684-8728
Ridgetop Group, Inc.	1QDG8	Tucson, AZ	Design	Director, Marketing and Sales	Marketing@ridgetopgroup.com	(520) 742-3300
Rockwell Collins, Inc.	13499	Cedar Rapids, IA	Design; Packaging/Assembly; Test	Tate Hamann	jthamann@rockwellcollins.com	(319)-295-1422
Sandia National Laboratories Microsystems Science, Technology, & Components	14213	Albuquerque, NM	Design; Foundry Services; Test	Fred Sexton, Manager, Advanced MicroElectronics & Radiation EffectsTechnology	sextonfw@sandia.gov	(505) 844-3927
Silanna Semiconductor	Z0FS6	Sydney Olympic Park, New South Wales, Australia	Design; Foundry Services; Post Processing	Andrew Greatbatch	andrew.greatbatch@silanna.com	office +61 2 9763 4134 cell +61 409 454 130
Smart System Technology & Commercialization Center	4MKQ5	Canandaigua, NY	Aggregation; Post Processing; Packaging/Assembly	Paul Tolley, Executive Director	paul.tolley@stcmems.com	(585) 919-3001
SRI International	0DKS7	Princeton, NJ	Foundry Services	Justine Corboy Director, Business Development	justine.corboy@sri.com	(609) 734-2168
SypherMedia International	458E4	Westminster, CA	Design	Gregory J. Gagnon	gjgagnon@smi.tv	(714) 895 8801x102
Sypris Electronics	24384	Tampa, Fl	Design	Julian Parker	julian.parker@sypris.com	(813) 972-6000
Tahoe RF Semiconductor, Inc.	4DGT5	Auburn, CA	Broker; Design	Business Development Manager, Trusted Solutions	trustedic@tahoerf.com	(530) 823-9786 x232
Teledyne Microelectronic Technologies	16170	Los Angeles, CA	Packaging/Assembly; Test	Harry Kellzi, Director, Business Development	hkellzi@teledyne.com	(310) 574-2097
TriQuint Semiconductor Texas	1CVM1	Richardson, TX	Foundry Services; Post Processing; Packaging/Assembly; Test	Doug Reep	douglas.reep@tqs.com	(972) 994-8323
USC-ISI - MOSIS	1B729	Marina del Rey, CA	Broker; Aggregation	Wes Hansford, Deputy Director	hansford@mosis.com	(310) 448-9199
Vortex Aerospace Design & Labs, Inc.	35TC6	Melbourne, FL	Broker; Design; Aggregation	Curtis Turner	trustedDesign@vortexaerospace.com	(813) 454-1906
White Electronic Designs Corporation	0B132	Phoenix, AZ	Broker; Packaging/Assembly; Test	Director of Sales	trusted@wedc.com	(602) 437-1520
Zephyr Photonics, Inc.	6CAV2	Zephyr Cove, NV	Foundry Services; Packaging/Assembly	Chief Technology Officer (CTO)	trusted@zephyrphotonics.com	(775) 588-4176

The Defense MicroElectronics Activity (DMEA) has been designated by the Department of Defense through the Trusted Access Program Office (TAPO) as the accrediting authority for this program. Send questions or comments to TrustedIC@dmea.osd.mil or call (916) 231-1514.

Trusted Integrated Circuit Supplier Fabrication Processes



As of 22 Feb 2013